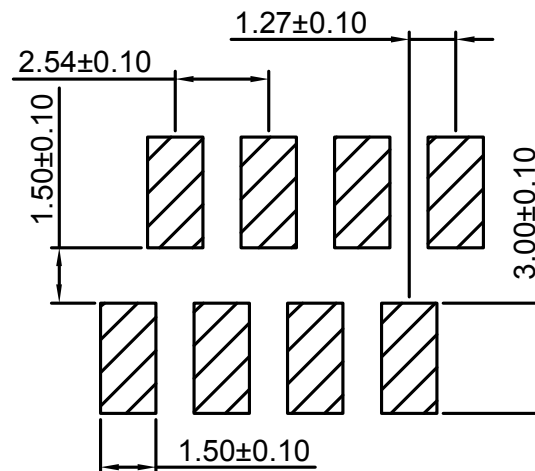
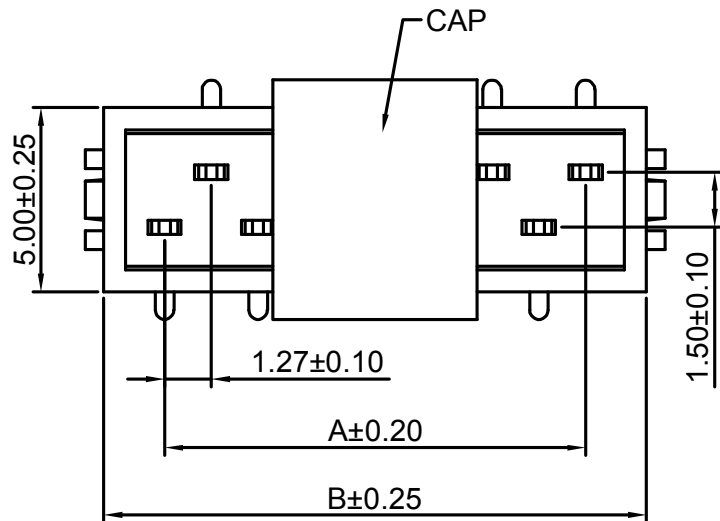
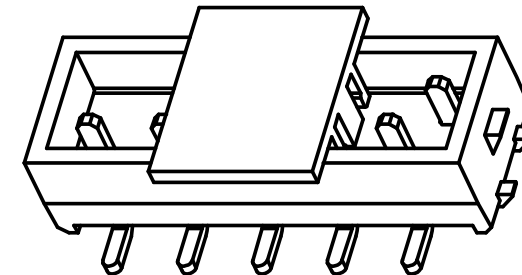


修订 REV	标记 MARK	修改摘要 REVISION DESCRIPTION	签名 SIGNATURE	日期 DATE
A0		NEW RELEASE	WANG	2017-12-18



P.C.B LAYOUT



Ordering Information & Dimensions:

PART NO.	Dimensions	
	A	B
4P	3.81	7.11
6P	6.35	9.65
8P	8.89	12.19
10P	11.43	14.73
12P	13.97	17.27
14P	16.51	19.81
16P	19.05	22.35
18P	21.59	24.89
20P	24.13	27.43
22P	26.67	29.97
24P	29.21	32.51
26P	31.75	35.05

Unit: mm

Ordering Information:

HDGC1277HMMWV-S-XP - ***
1 2

1.Part No.

2:Material:

(blank):Nylon 6T,UL94V-0

GWT:Nylon 6T,UL94V-0,GWT 750°C



深圳市华德共创科技有限公司

Shenzhen Huade co-create Technology Co.,LTD

TEL : 0755-27129737 FAX : 0755-29940187

-TOLERANCES- UNLESS OTHERWISE SPECIFIED 公差参数表					TITLE: 1.27mm Pitch 产品名称: IDC 180 ° Wafer			
X.X	±0.30	X.X°	±3°	APPD: 核准: XIE	PART NO: HDGC1277HMMV-S-XP 产品编号:			
X.XX	±0.30	X.XX°	±2°	CHECK: 校对: WANG	DATE	SCALE	UNIT	CODE NUMBER
X.XXX	±0.10	X.XXX°	±1°	DRAW: 绘图: WANG	2017-12-18	8:1	mm	A008